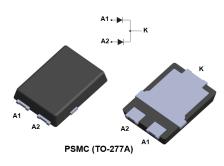


STTH1002CSF

Datasheet

200 V, dual 5 A ultrafast rectifier



Features

- 175 °C maximum operation junction temperature
- High surge current capability
- ECOPACK2 compliant component

Application

- DC/DC converters
- Freewheeling diodes
- LED Lighting

Description

The STTH1002CSF has been developed for applications requiring an optimized VF and reverse recovery characteristics.

These characteristics make it ideal for use in secondary rectification functions, such as DC/DC converters or lighting applications.

Product status link				
STTH1002CSF				
Product summary				
Symbol Value				
I _{F(AV)}	2 X 5 A			
V _{RRM}	200 V			
t _{rr} (max)	27 ns			
T _j (max.)	175 °C			
V _F (typ.)	0.79 V			

1 Characteristics

(1)

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified, per diode)

Symbol	Parameter			Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	200	V			
		Per diode	T _c = 160 °C	5		
IF(AV)	$I_{F(AV)}$ Average forward current, $\delta = 0.5$	Per device	T _c = 160 °C	10	A	
I _{FSM}	Surge non repetitive forward current t_p = 10 ms sinusoidal			85	А	
T _{stg}	Storage temperature range	-65 to +175	°C			
Tj	Maximum operating junction temperature range			+175	°C	

Table 2. Thermal resistance parameters

Symbol	Parameter		Тур.	Unit
Pu a s	Junction to case	Per diode	2.45	°C/W
R _{th(j-c)}	Junction to case	Per device	1.66	C/W
Rth(c)	Coupling		0.87	°C/W

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_{j \text{ (diode1)}} = P_{(diode1)} \times R_{th(j-c)} \text{ (per diode)} + P_{(diode2)} \times R_{th(c)}$

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	T _j = 25 °C		-		4		
'R''	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	V _R = V _{RRM}	-	4	40	μA
		T _j = 25 °C	I _F = 5 A	-	0.91	1.05	V
N/ (2)	Forward voltage drap	T _j = 125 °C		-	0.79	0.91	
VF		T _j = 25 °C		-	1.02	1.17	v
		T _j = 125 °C	I _F = 10 A	-	0.90	1.04	

1. Pulse test: $t_p = 5 ms$, $\delta < 2\%$

2. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses, use the following equation:

 $P = 0.78 \text{ x } I_{F(AV)} + 0.026 \text{ x } I_{F}^{2}(RMS)$

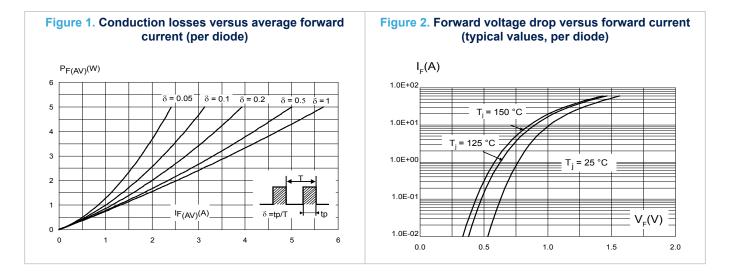
For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
+	t_{rr} Reverse recovery time $T_j = 25$	T _i = 25 °C	I_F = 1 A, d I_F /dt = -50 A/µs, V _R = 30 V	-	28	35	ns
۲r			I_F = 1 A, d I_F /dt = -100 A/µs, V _R = 30 V	-	21	27	115
I _{RM}	Reverse recovery current	T _j = 125 °C	I_F = 5 A, d I_F /dt = -200 A/µs, V_R = 160 V	-	6.3		Α

Table 4. Dynamic characteristics per diode at T_j = 25°C, unless otherwise specified

1.1 Characteristics (curves)



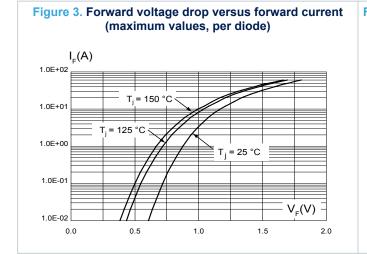
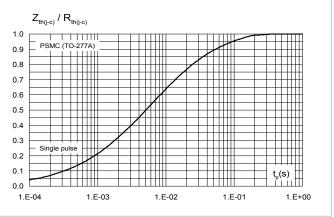
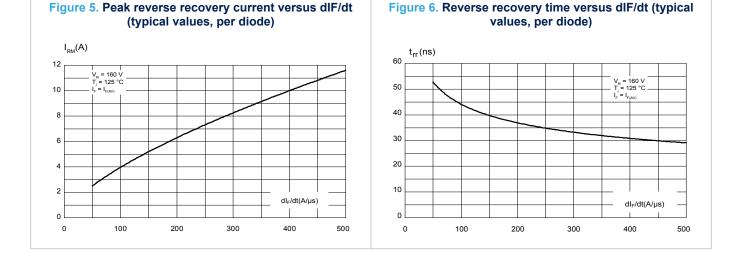


Figure 4. Relative variation of thermal impedance junction to case total versus pulse duration





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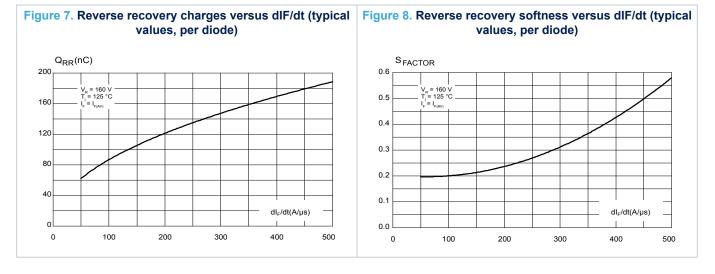


Figure 9. Relative variations of dynamic parameters versus junction temperature C(pF) 2.0 100 $V_R = 160 V$ $I_F = I_{F(AV)}$ Reference: $T_i = 125 °C$ 1.6 $\mathsf{S}_{_{\mathsf{FACTOR}}}$ 1.2 -----10 I_{RM} 0.8 - -- - - - | - - - -

100

T_j(°C)

125

75

 $\mathsf{Q}_{_{\!\!\mathsf{R}\!\!\mathsf{R}}}$

50

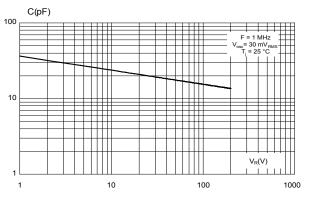
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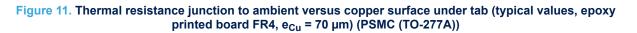
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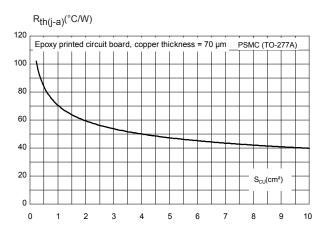
0.0

25

Figure 10. Junction capacitance versus reverse voltage applied (typical values, per diode)







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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 PSMC (TO-277A) package information

- Epoxy meets UL94,V0
- Cooling method : by conduction (C)

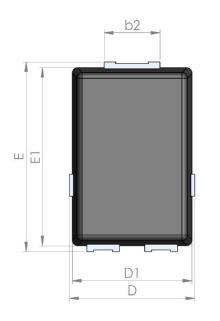
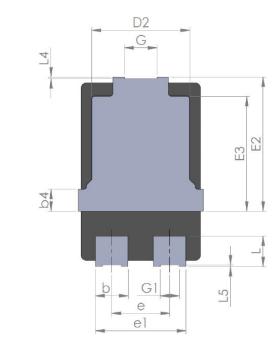


Figure 12. PSMC (TO-277A) package outline

С

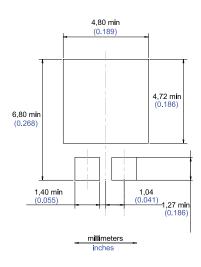




		Dimensions						
Ref.		Millimeters		Inch	es (for reference o	only)		
	Min.	Тур.	Max.	Min.	Тур.	Max.		
А	1.00	1.10	1.20	0.039	0.043	0.047		
b	1.05	1.20	1.35	0.041	0.047	0.053		
b2	1.90	2.05	2.20	0.075	0.081	0.087		
b4		0.75			0.029			
С	0.15	0.23	0.40	0.006	0.009	0.016		
D	4.45	4.60	4.75	0.175	0.181	0.187		
D1	4.25	4.40	4.45	0.167	0.173	0.175		
D2	3.40	3.60	3.70	0.134	0.142	0.146		
E	6.35	6.50	6.65	0.250	0.256	0.262		
E1	6.05	6.10	6.15	0.238	0.240	0.242		
E2	4.50	4.60	4.70	0.177	0.181	0.185		
E3		3.94			1.55			
е		2.13			0.084			
e1		3.33			0.131			
G		1.20			0.047			
G1		0.70			0.027			
L	0.90	1.05	1.24	0.035	0.041	0.049		
L4	0.02			0.0008				
L5	0.02			0.0008				

Table 5. PSMC (TO-277A) package mechanical data

Figure 13. PSMC (TO-277A) package footprint in mm (in inches)



Note: For package and tape orientation, reel and inner box dimensions and tape outline please check TN1173



3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH1002CSF	TH1002C	PSMC (TO-277A)	90 mg	6000	Tape and Reel

Revision history

Table 7. Document revision history

Date	Version	Changes
29-Oct-2020	1	Initial release.



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